

# BYR29X-600

Rectifier diode ultrafast

Rev. 01 — 26 September 2003

Product data

## 1. Product profile

### 1.1 Description

Ultra-fast, epitaxial rectifier diode in a plastic package.

### 1.2 Features

- Low forward voltage
- Fast switching
- Soft recovery characteristic
- Isolated mounting base.

### 1.3 Applications

- Switched-mode power supplies
- Low loss rectification.

### 1.4 Quick reference data

- $V_R \leq 600 \text{ V}$
- $V_F \leq 1.5 \text{ V}$
- $I_{F(AV)} \leq 8 \text{ A}$
- $t_{rr} \leq 75 \text{ ns}$

## 2. Pinning information

Table 1: Pinning - SOD113, simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1	cathode (k)	<p style="text-align: center;">Top view <span style="float: right;">MBK088</span></p> <p style="text-align: center;"><b>SOD113</b></p>	<p style="text-align: center;">001aaa020</p>
2	anode (a)		
mb	mounting base; isolated		



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### 3. Ordering information

Table 2: Ordering information

Type number	Package		Version
	Name	Description	
BYR29X-600	-	Plastic single-ended package; isolated heatsink mounted; 2-leads	SOD113

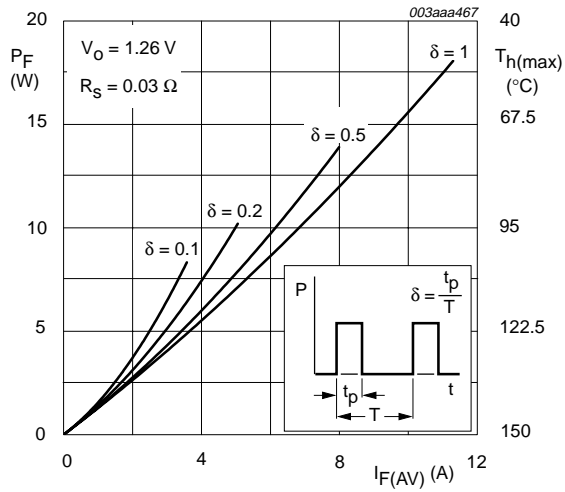
### 4. Limiting values

Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	600	V
$V_{RWM}$	crest working reverse voltage		-	600	V
$V_R$	reverse voltage	$T_h \leq 136 \text{ }^\circ\text{C}$	-	600	V
$I_{F(AV)}$	average forward current	square wave; $\delta = 0.5$ ; $T_h \leq 73 \text{ }^\circ\text{C}$	[1] -	8	A
$I_{FRM}$	repetitive peak forward current	square wave; $t = 25 \text{ } \mu\text{s}$ ; $\delta = 0.5$ ; $T_h \leq 73 \text{ }^\circ\text{C}$	-	16	A
$I_{FSM}$	non-repetitive peak forward current	sinusoidal; with reapplied $V_{RRM(max)}$			
		$t_p = 10 \text{ ms}$	-	60	A
		$t_p = 8.3 \text{ ms}$	-	66	A
$T_{stg}$	storage temperature		-40	+150	$^\circ\text{C}$
$T_j$	junction temperature		-	+150	$^\circ\text{C}$

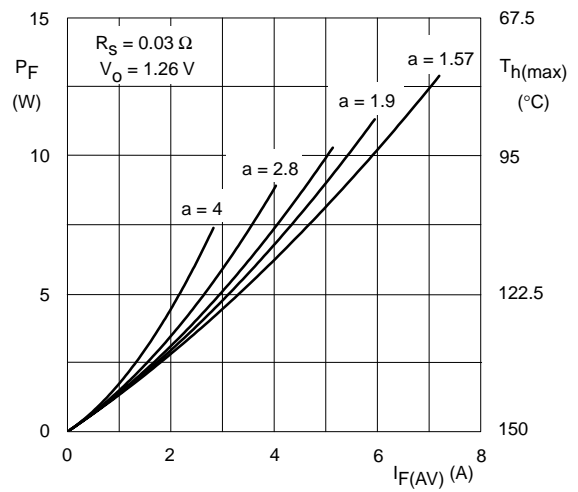
[1] Neglecting switching and reverse current losses.



Square current waveform

$$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$$

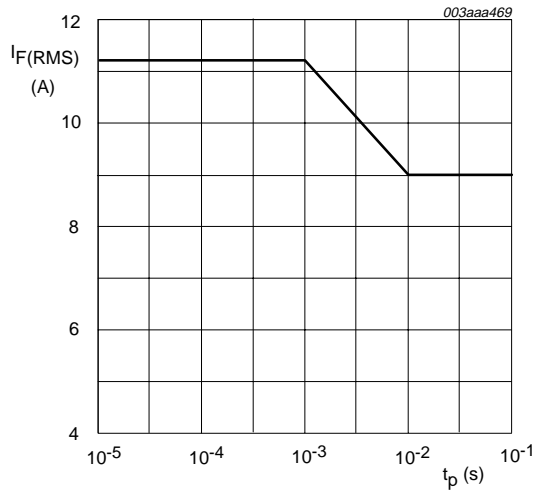
**Fig 1. Maximum forward power dissipation (square current waveform) and maximum permissible heatsink temperature as a function of average forward current.**



Sinusoidal current waveform

$$a = \frac{I_{F(RMS)}}{I_{F(AV)}}$$

**Fig 2. Maximum forward power dissipation (sinusoidal current waveform) and maximum permissible heatsink temperature as a function of average forward current.**



**Fig 3. Maximum permissible forward RMS current as a function of pulse width.**

## 5. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	with heatsink compound; <b>Figure 4</b>	-	-	5.5	K/W
		without heatsink compound	-	-	7.2	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	55	-	K/W

### 5.1 Transient thermal impedance

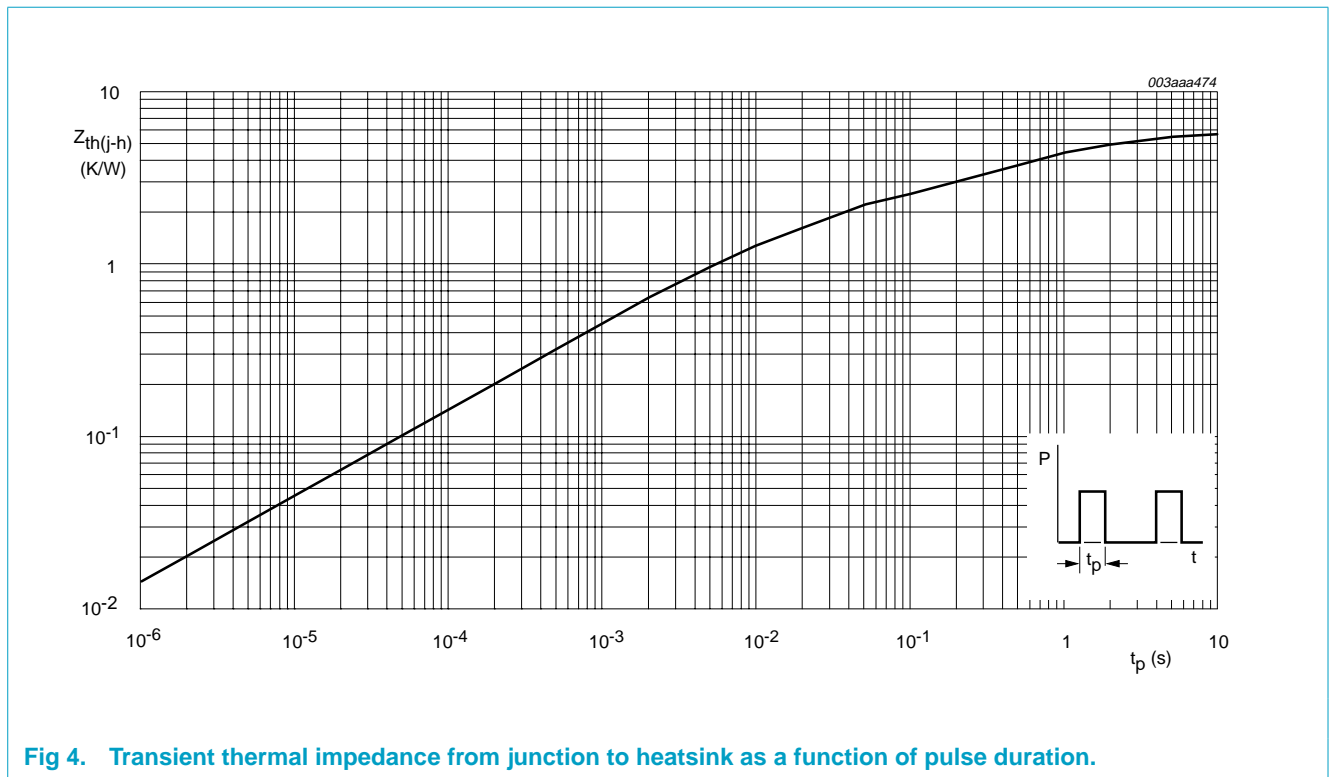


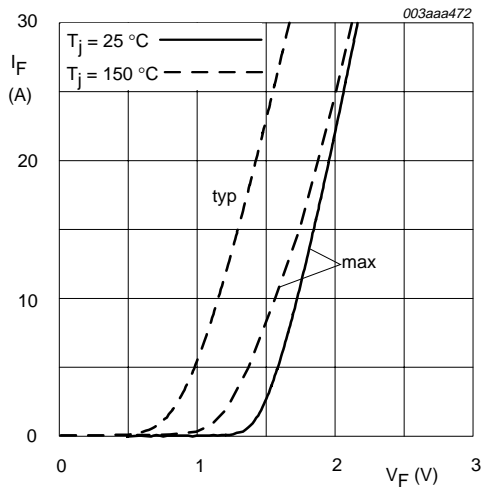
Fig 4. Transient thermal impedance from junction to heatsink as a function of pulse duration.

## 6. Characteristics

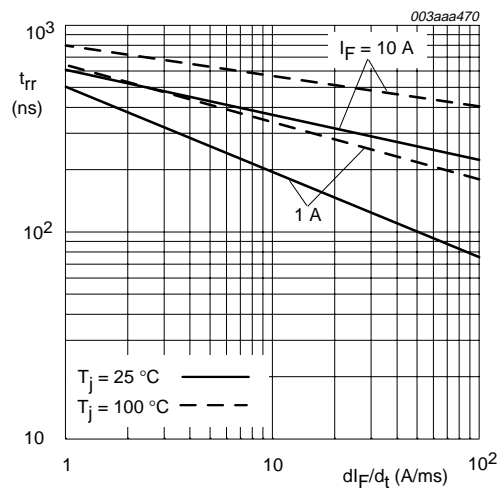
**Table 5: Characteristics**

$T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$V_F$	forward voltage	$I_F = 8\text{ A}$				
		$T_j = 150\text{ }^\circ\text{C}$ ; <b>Figure 5</b>	-	1.07	1.5	V
		$T_j = 25\text{ }^\circ\text{C}$ ; <b>Figure 5</b>	-	-	1.7	V
$I_R$	reverse current	$I_F = 20\text{ A}$	-	1.75	1.95	V
		$V_R = V_{RRM}$				
		$T_j = 100\text{ }^\circ\text{C}$	-	0.1	0.2	mA
		$T_j = 25\text{ }^\circ\text{C}$	-	1	10	$\mu\text{A}$
		<b>Dynamic characteristics</b>				
$Q_r$	recovered charge	$I_F = 2\text{ A}$ ; $V_R \geq 30\text{ V}$ ; $di_F/dt = 20\text{ A}/\mu\text{s}$ ; <b>Figure 8</b>	-	150	200	nC
$t_{rr}$	reverse recovery time	$I_F = 1\text{ A}$ ; $V_R \geq 30\text{ V}$ ; $di_F/dt = 100\text{ A}/\mu\text{s}$ ; <b>Figure 6</b>	-	60	75	ns
$I_{rrm}$	peak reverse recovery current	$I_F = 10\text{ A}$ ; $V_R \geq 30\text{ V}$ ; $di_F/dt = 50\text{ A}/\mu\text{s}$ ; $T_j = 100\text{ }^\circ\text{C}$ ; <b>Figure 7</b>	-	-	6	A
$V_{fr}$	forward recovery voltage	$I_F = 10\text{ A}$ ; $di_F/dt = 10\text{ A}/\mu\text{s}$	-	5	-	V



**Fig 5. Forward current as a function of forward voltage; typical values.**



**Fig 6. Maximum reverse recovery time as a function of rate of change of forward current.**

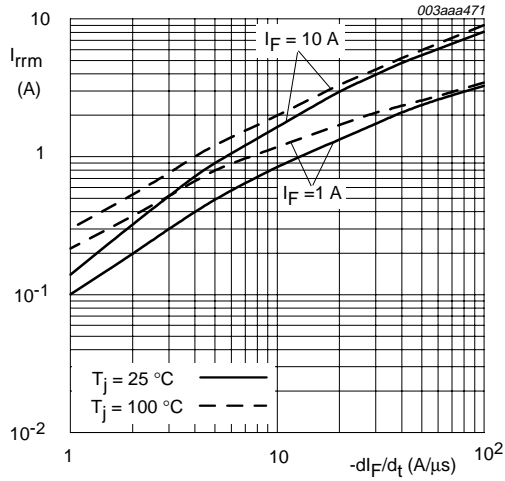


Fig 7. Maximum reverse current as a function of rate of change of forward current.

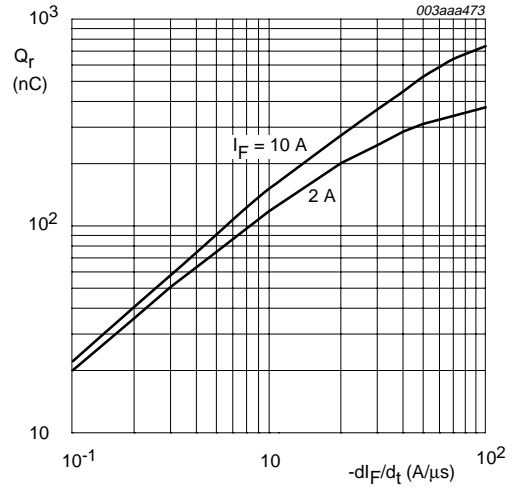


Fig 8. Maximum recovered charge as a function of rate of change of forward current.

## 7. Isolation characteristics

Table 6: Isolation characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{(isol)MR}$	Repetitive peak isolation voltage from both terminals to external heatsink.	RH $\leq$ 65%; clean and dust-free.	-	-	1500	V
$C_{(k-h)}$	Capacitance from cathode to external heatsink.		-	12	-	pF

8. Package outline

Plastic single-ended package; isolated heatsink mounted;  
1 mounting hole; 2-lead TO-220 'full pack'

SOD113

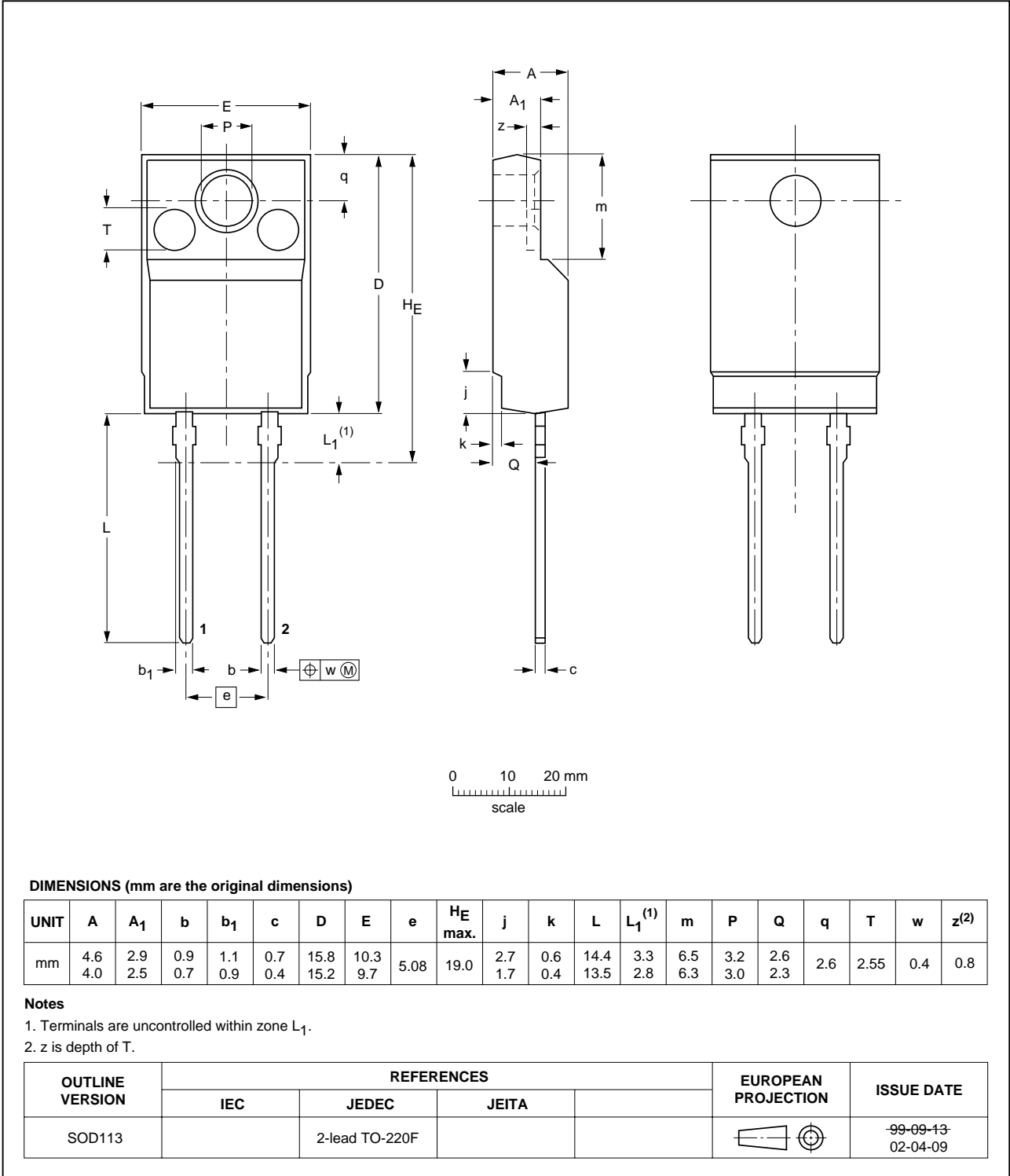


Fig 9. SOD113.

## 9. Revision history

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Table 7: Revision history

Rev	Date	CPCN	Description
01	20030926	-	Product data (9397 750 12006).



## 10. Data sheet status

Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2][3]</sup>	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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